

ECPLC5B5CL

core

Low-Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

The ECPLC5B5CL is designed with Ecore Punch-Through process TVS technology to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, VGA, DVI, SDI and other high speed line applications.

It has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD(electrostatic discharge), and EFT (electrical fast transients).

Features

- Peak Power Dissipation 60 W (8 x 20 us Waveform)
- Stand-off Voltage: 5.0 V
- Replacement for MLV (0603)
- Protects I/O Port
- Low Clamping Voltage
- Low Leakage
- Low Capacitance
- Low capacitance (<6.0pF) for high-speed interfaces
- No insertion loss to 1.0GHz
- Response Time is < 1 ns
- Meets MSL 1 Requirements
- ROHS compliant
- Solid-state Punch-Through TVS Process technology

Main applications

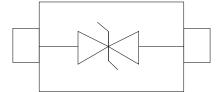
- High Speed Line :USB1.0/2.0, VGA, DVI, SDI,
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Projection TV
- Cellular handsets and accessories
- Portable instrumentation
- Peripherals

Protection solution to meet

- IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)



SOD-523



Ordering Information

Device	Qty per Reel	Reel Size
ECPLC5B5CL	3000	7 Inch

<u>Ecore</u>

ECPLC5B5CL

Maximum ratings (Tamb=25°C Unless Otherwise Specified)						
Parameter	Symbol	Value	Unit			
Peak Pulse Power (tp=8/20µs waveform)	Рррр	60	Watts			
ESD Rating per IEC61000-4-2: Contact		8	VV			
Air		15	KV			
Lead Soldering Temperature	TL	260 (10 sec.)	°C			
Operating Temperature Range	ΤJ	-55 ~ 150	°C			
Storage Temperature Range	Tstg	-55 ~ 150	°C			
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	°C			

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not

normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

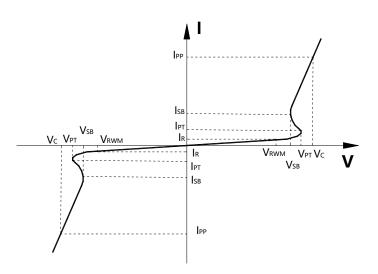
*Other voltages may be available upon request.

1. Non-repetitive current pulse, per Figure 1.

Electrical characteristics (Tamb=25°C Unless Otherwise Specified)						
	V _{RWM}	I _R @	Vrwm	V _{SB} @ 50 mA	Vc	Capacitance
Device	V RWM	(u.	A)	(Volts)	@ 1 A	(a) $V_R = 2 V, 1 MHz (pF)$
	(V)	Тур	Max	Min	(V)	Тур
ECPLC5B5CL	5.0	0.05	1	5.2	9.0	3

Junction capacitance is measured in VR=0V,F=1MHz

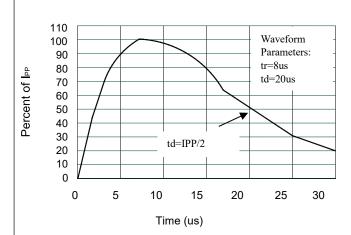
Symbol	Parameter
Vrwm	Working Peak Reverse Voltage
Vpt	Punch-Through Voltage@ IPT
Vsb	Snap-Back Voltage@ IsB
Vc	Clamping Voltage @ IPP
IT	Test Current
Irm	Leakage current at VRWM
Ірр	Peak pulse current
Co	Off-state Capacitance
CJ	Junction Capacitance



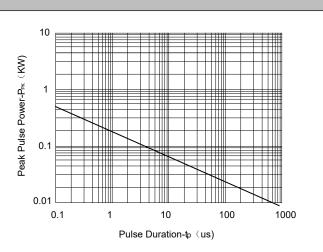


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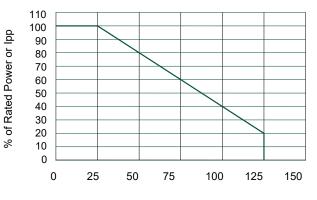
Typical electrical characterist applications



Pulse Waveform

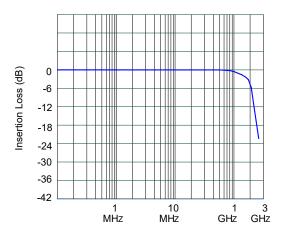


Non-Repetitive Peak Pulse Power vs. Pulse Time



Ambient Temperature-T A (°C)

Power Derating Curve



Insertion Loss S21



Typical applications

